SEMICONDUCTOR®

## November 2013

## FQP3N30

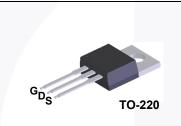
## **N-Channel QFET<sup>®</sup> MOSFET** 300 V, 3.2 A, 2.2 Ω

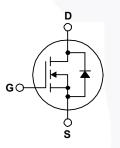
## Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

### Features

- 3.2 A, 300 V,  $R_{DS(on)}$  = 2.2  $\Omega$  (Max.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 1.6 A
- Low Gate Charge (Typ. 5.5 nC)
- Low Crss (Typ. 6 pF)
- 100% Avalanche Tested





## Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

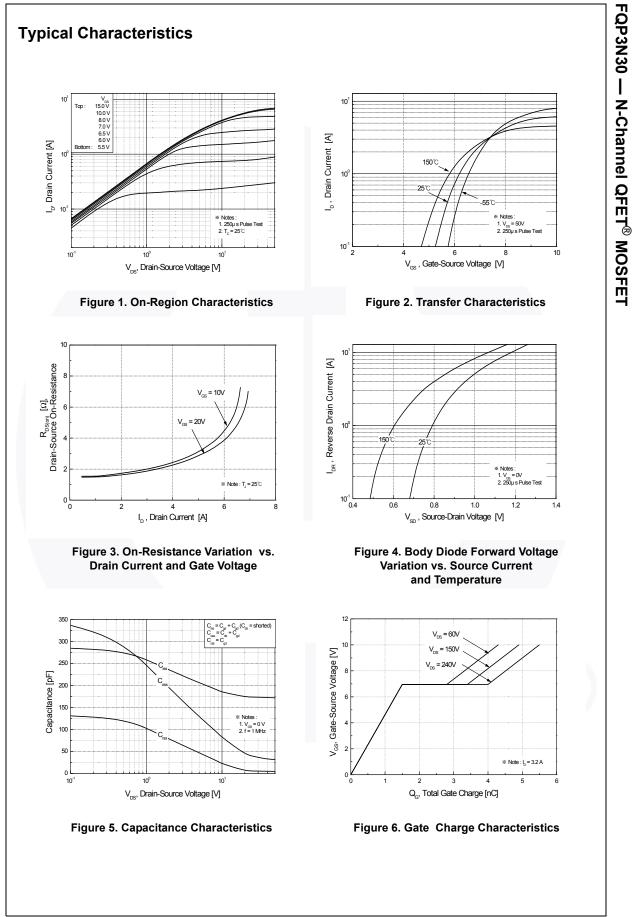
Symbol	Parameter		FQP3N30	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		300	V	
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^\circ$	C)	3.2	A	
	- Continuous (T <sub>C</sub> = 100	°C)	2.02	А	
DM	Drain Current - Pulsed	(Note 1)	12.8	А	
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	140	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	3.2	А	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	5.5	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns	
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)		55	W	
	- Derate above 25°C		0.44	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Ran	ge	-55 to +150	°C	
TL	Maximum Lead Temperature for Solderin 1/8" from Case for 5 seconds	ıg,	300	°C	

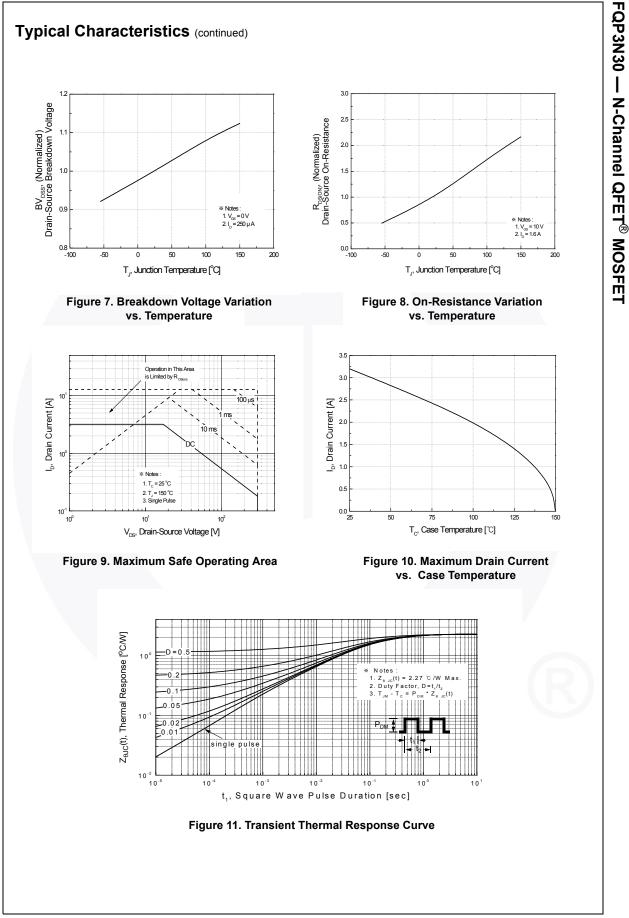
## **Thermal Characteristics**

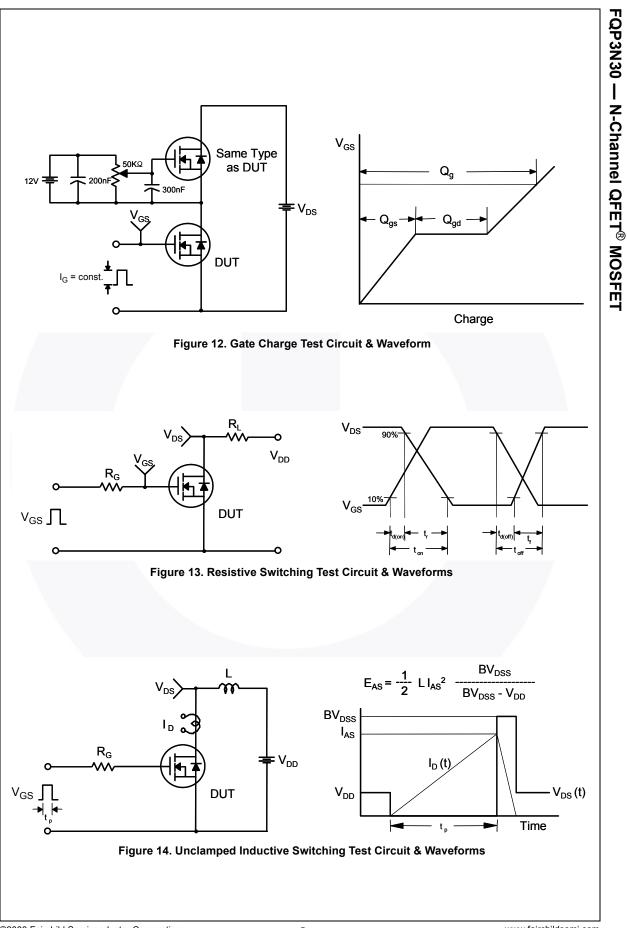
Symbol	Parameter	FQP3N30	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	2.27	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

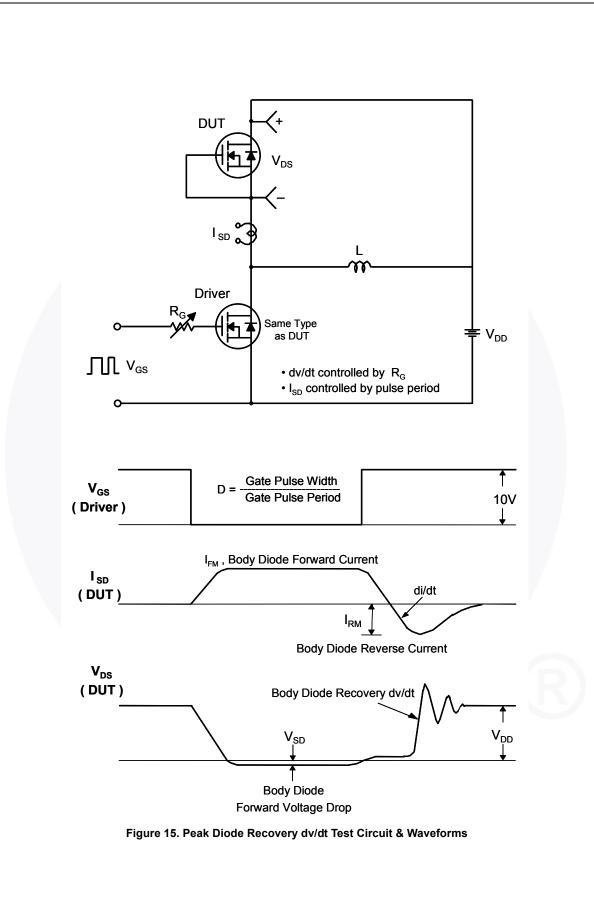
Part NumberTop MarkPackageFQP3N30FQP3N30TO-220		Package	Packing Method	Reel Size	Tape Width		th Q	Quantity	
		TO-220	Tube N/A		N/A		5	50 units	
lectri	cal Cl	naracteristics	T <sub>C</sub> = 25°C	unless otherwise noted.					
Symbol		Parameter		Test Conditi	ons	Min	Тур	Max	Unit
	rootor	iation							
BV <sub>DSS</sub>	aracteristics		oltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 µ	IA	300			V
ABV <sub>DSS</sub>	Drain-Source Breakdown Voltage Breakdown Voltage Temperature Coefficient		0	$I_D = 250 \mu\text{A}$ , Referenced to 25°C		500			v
$\Delta T_{J}$			alure				0.35		V/°C
				V <sub>DS</sub> = 300 V, V <sub>GS</sub> = 0	) V			1	μA
033	Zero G	Zero Gate Voltage Drain Current		$V_{\rm DS}$ = 240 V, T <sub>C</sub> = 12				10	μΑ
GSSF	Gate-E	Body Leakage Curren	t, Forward	$V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0$	V			100	nA
GSSR		Body Leakage Curren		$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0$				-100	nA
									ı
On Cha				N/ N/ 1 6-1					
V <sub>GS(th)</sub>		Threshold Voltage		$V_{DS} = V_{GS}, I_D = 250$	μA	3.0		5.0	V
R <sub>DS(on)</sub>		Drain-Source sistance		$V_{GS}$ = 10 V, $I_{D}$ = 1.6 J	A		1.65	2.2	Ω
FS	Forwa	rd Transconductance		$V_{\rm DS}$ = 50 V, I <sub>D</sub> = 1.6 J	A		1.75		S
	1	racteristics						1	
C <sub>iss</sub>		Capacitance		$V_{DS}$ = 25 V, $V_{GS}$ = 0	V,		175	230	pF
C <sub>oss</sub>		Capacitance		f = 1.0 MHz			40	50	pF
C <sub>rss</sub>	Revers	se Transfer Capacitar	nce				6	8	pF
Switch	ina Ch	aracteristics							
d(on)	· · · · · · · · · · · · · · · · · · ·	n Delay Time					10	30	ns
r		n Rise Time		$V_{DD} = 150 \text{ V}, \text{ I}_{D} = 3.2$	2 A,		40	90	ns
d(off)		off Delay Time		R <sub>G</sub> = 25 Ω			10	30	ns
f		Off Fall Time			(Note 4)		25	60	ns
Qq		Bate Charge		$V_{-} = 240 V_{-} = 3.2$	۰ ۸		5.5	7.0	nC
∽y ⊋ <sub>gs</sub>		Source Charge		V <sub>DS</sub> = 240 V, I <sub>D</sub> = 3.2 V <sub>GS</sub> = 10 V	Α,		1.5		nC
∽gs Q <sub>gd</sub>		Drain Charge		v <sub>GS</sub> - 10 v	(Note 4)		2.5		nC
∽ga	Outo L				(		2.0		no
Drain-S	ource	Diode Characte	eristics an	d Maximum Rati	ngs				
s	Maxim	um Continuous Drair	-Source Dio	de Forward Current	-			3.2	Α
SM	Maxim	um Pulsed Drain-Sou	urce Diode Fo	orward Current			/	12.8	А
V <sub>SD</sub>	Drain-	Source Diode Forwar	d Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 3.2 A				1.5	V
-rr		se Recovery Time	Ŭ	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 3.2 \text{ A}$			120		ns
Q <sub>rr</sub>		se Recovery Charge		dI <sub>F</sub> / dt = 100 A/µs			0.4		μC
11									

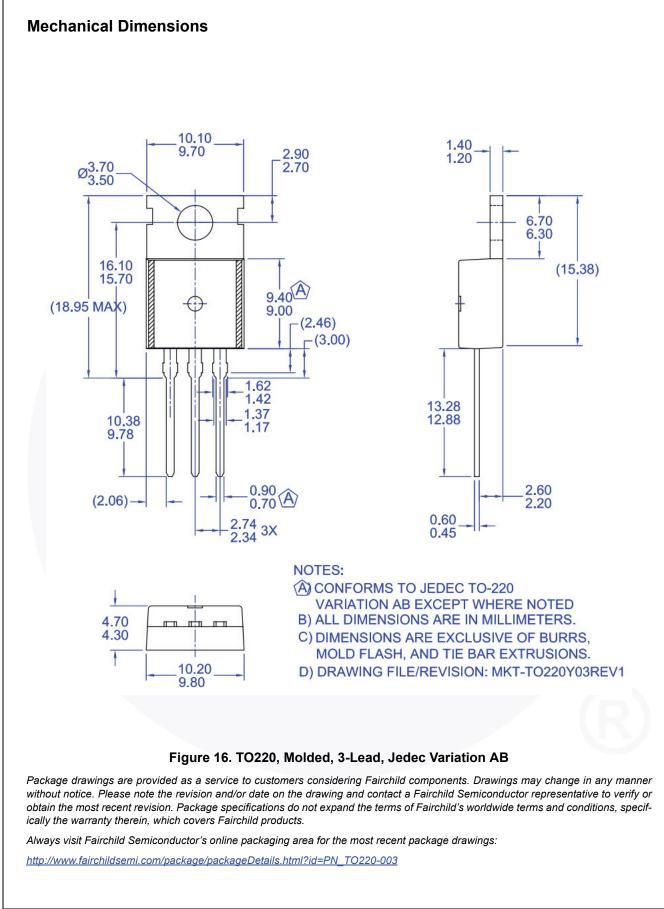
FQP3N30 — N-Channel QFET<sup>®</sup> MOSFET













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